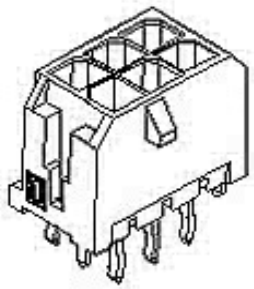
Part Number : 440672001
Product Description : Micro-Fit 3.0 Wire-to-Board Header, Dual Row, Vertical for up to 3.56mm Thick PCB, 20 Circuits, Tin (Sn) Plating
Series Number : 44067
Status : Active
Product Category : PCB Headers and Receptacles



Documents & Resources

Drawings

440672001_sd.pdf

PK-70873-0314-001.pdf

3D Models and Design Files

STEP AP242

SOLIDWORKS

Creo

Symbol and Footprint (Multi-Format)

SYM-44067-200X-001.zip

Specifications

430450001-PS-KO-000.pdf

430450001-PS-SP-000.pdf

PS-43045-001.pdf

430450005-TS-000.pdf

430450007-TS-000.pdf

TS-43045-001-001.pdf

TS-43045-002-001.pdf

TS-46235-001-001.pdf

Product Environment Compliance

Compliance

GADSL/IMDS	Not Relevant
China RoHS	

	per SJ/T 11365-2006
EU ELV	Not Relevant
Low-Halogen Status	Low-Halogen per IEC 61249-2-21
REACH SVHC	Not Contained per D(2025)4165-DC (25 June 2025)
EU RoHS	Compliant per EU 2015/863

Compliance Statements

- EU RoHS
- REACH SVHC
- Low-Halogen

Industry Documents

- IPC 1752A Class C
- IPC 1752A Class D
- Molex Product Compliance Declaration
- IEC-62474
- chemSHERPA (xml)

Substances of Interest

- PFAS

EU RoHS Certificate of Compliance

Additional Product Compliance Information

Part Details

General

Status	Active
Category	PCB Headers and Receptacles
Series	44067
Description	Micro-Fit 3.0 Wire-to-Board Header, Dual Row, Vertical for up to 3.56mm Thick PCB, 20 Circuits, Tin (Sn) Plating
Application	Power, Wire-to-Board
Comments	High Temperature, Polarization Key to PCB
Component Type	PCB Header
Product Name	Micro-Fit 3.0
UPC	800756476407

Agency

UL	E29179

Electrical

Current - Maximum per Contact	8.5A
Voltage - Maximum	250V

Physical

Breakaway	No
Circuits (Loaded)	20
Circuits (maximum)	20
Color - Resin	Black
Durability (mating cycles max)	30
First Mate / Last Break	No
Flammability	94V-0
Glow-Wire Capable	No
Guide to Mating Part	No
Keying to Mating Part	None
Lock to Mating Part	Yes
Material - Plating Mating	Tin
Material - Plating Termination	Tin
Material - Resin	High Temperature Thermoplastic
Net Weight	2.757/g
Number of Rows	2
Orientation	Vertical
Packaging Type	Tray
PCB Locator	Yes
PCB Retention	Yes
PCB Thickness - Recommended	3.60mm
PC Tail Length	4.01mm
Pitch - Mating Interface	3.00mm
Pitch - Termination Interface	3.00mm
Plating min - Mating	2.540µm
Plating min - Termination	2.540µm
Polarized to PCB	Yes

Shrouded	Fully
Stackable	No
Temperature Range - Operating	-40° to +105°C
Termination Interface Style	Through Hole - Kinked Pin

Solder Process Data

Max-Duration	30
Lead-Free Process Capability	SMC&WAVE
Max-Cycle	3
Max-Temp	260

Mates With / Use With

Mates with Part(s)

Description	Part Number
Micro-Fit 3.0 Dual Row Receptacle Housings	43025